

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Field device tool (FDT) interface specification –
Part 1: Overview and guidance**

**Spécification des interfaces des outils des dispositifs de terrain (FDT) –
Partie 1: Vue d'ensemble et guide**





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INTERNATIONAL ELECTROTECHNICAL COMMISSION

FIELD DEVICE TOOL (FDT) INTERFACE SPECIFICATION –**Part 1: Overview and guidance**

FOREWORD

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International Standard IEC 62453-1 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

This second edition cancels and replaces the first edition published in 2009. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition: introduction of a new implementation technology (defined in IEC 62453-42).

The text of this standard is based on the following documents:

CDV	Report on voting
65E/333/CDV	65E/393A/RVC

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of the IEC 62453 series, under the general title *Field Device Tool (FDT) interface specification*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
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INTRODUCTION

Enterprise automation requires two main data flows: a “vertical” data flow from enterprise level down to the field devices including signals and configuration data, and a “horizontal” communication between field devices operating on the same or different communication technologies.

With the integration of fieldbuses into control systems, there are a few additional tasks to be performed. They may result in a large number of fieldbus- and device-specific tools in addition to system and engineering tools. Integration of these tools into higher-level system-wide planning or engineering tools is an advantage. In particular, for use in extensive and heterogeneous control systems, typically in the area of the process industry, the unambiguous definition of engineering interfaces that are easy to use for all those involved is of great importance.

Several different manufacturer specific tools are used. The data in these tools are often invisible data islands from the viewpoint of system life-cycle management and plant-wide automation.

To ensure the consistent management of a plant-wide control and automation technology, it is important to fully integrate fieldbuses, devices and sub-systems as a seamless part of a wide range of automation tasks covering the whole automation life-cycle.

IEC 62453 provides an interface specification for developers of FDT (Field Device Tool) components to support function control and data access within a client/server architecture. The availability of this standard interface facilitates development of servers and clients by multiple manufacturers and supports open interoperation.

A device or module-specific software component, called a DTM (Device Type Manager) is supplied by a manufacturer with the related device type or software entity type. Each DTM can be integrated into engineering tools via defined FDT interfaces. This approach to integration is in general open for all fieldbuses and thus supports integration of different devices and software modules into heterogeneous control systems.

The IEC 62453 common application interface supports the interests of application developers, system integrators, and manufacturers of field devices and network components. It also simplifies procurement, reduces system costs and helps manage the lifecycle. Significant savings are available in operating, engineering and maintaining the control systems.

The objectives of the IEC 62453 series are to support:

- universal plant-wide tools for life-cycle management of heterogeneous fieldbus environments, multi-manufacturer devices, function blocks and modular sub-systems for all automation domains (e.g. process automation, factory automation and similar monitoring and control applications);
- integrated and consistent life-cycle data exchange within a control system including its fieldbuses, devices, function blocks and modular sub-systems;
- simple and powerful manufacturer-independent integration of different automation devices, function blocks and modular sub-systems into the life-cycle management tools of a control system.

The FDT concept supports planning and integration of monitoring and control applications, it does not provide a solution for other engineering tasks such as “electrical wiring planning”, “mechanical planning”. Plant management subjects such as “maintenance planning”, “control optimization”, “data archiving”, are not part of this FDT standard. Some of these aspects may be included in future editions of FDT publications.